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Kind regards,

Team Nexperia

# PDTA123T series

PNP resistor-equipped transistors;  
 $R1 = 2.2 \text{ k}\Omega$ ,  $R2 = \text{open}$

Rev. 02 — 3 September 2009

Product data sheet

## 1. Product profile

### 1.1 General description

PNP Resistor-Equipped Transistors (RET) family.

Table 1. Product overview

| Type number              | Package |        |          | NPN complement |
|--------------------------|---------|--------|----------|----------------|
|                          | NXP     | JEITA  | JEDEC    |                |
| PDTA123TE                | SOT416  | SC-75  | -        | PDTC123TE      |
| PDTA123TK                | SOT346  | SC-59A | TO-236   | PDTC123TK      |
| PDTA123TM                | SOT883  | SC-101 | -        | PDTC123TM      |
| PDTA123TS <sup>[1]</sup> | SOT54   | SC-43A | TO-92    | PDTC123TS      |
| PDTA123TT                | SOT23   | -      | TO-236AB | PDTC123TT      |
| PDTA123TU                | SOT323  | SC-70  | -        | PDTC123TU      |

[1] Also available in SOT54A and SOT54 variant packages (see [Section 2](#))

### 1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 100 mA output current capability
- Reduces component count
- Reduces pick and place costs

### 1.3 Applications

- Digital applications
- Cost-saving alternative for BC857 series in digital applications
- Controlling IC inputs
- Switching loads

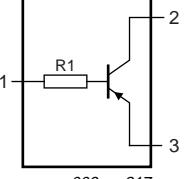
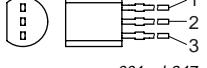
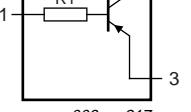
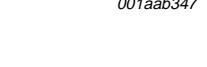
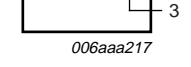
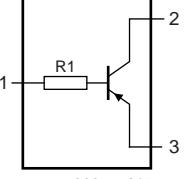
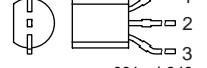
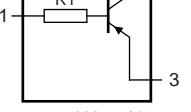
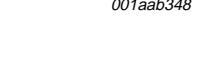
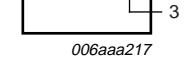
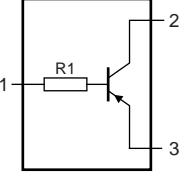
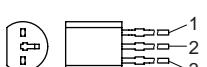
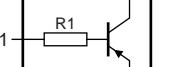
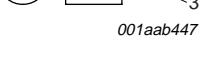
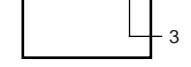
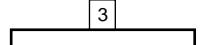
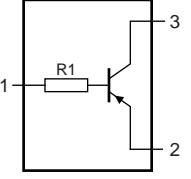
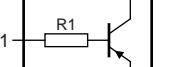
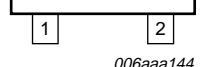
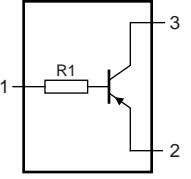
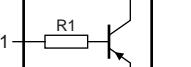
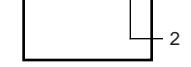
### 1.4 Quick reference data

Table 2. Quick reference data

| Symbol    | Parameter                 | Conditions | Min  | Typ | Max  | Unit             |
|-----------|---------------------------|------------|------|-----|------|------------------|
| $V_{CEO}$ | collector-emitter voltage | open base  | -    | -   | -50  | V                |
| $I_o$     | output current            |            | -    | -   | -100 | mA               |
| R1        | bias resistor 1 (input)   |            | 1.54 | 2.2 | 2.86 | $\text{k}\Omega$ |

## 2. Pinning information

Table 3. Pinning

| Pin                                  | Description        | Simplified outline   | Symbol  |
|--------------------------------------|--------------------|--|---|
| <b>SOT54</b>                         |                    |  |   |
| 1                                    | input (base)       |    |    |
| 2                                    | output (collector) |    |    |
| 3                                    | GND (emitter)      |    |    |
| <b>SOT54A</b>                        |                    |  |   |
| 1                                    | input (base)       |    |   |
| 2                                    | output (collector) |    |   |
| 3                                    | GND (emitter)      |   |   |
| <b>SOT54 variant</b>                 |                    |  |   |
| 1                                    | input (base)       |  |  |
| 2                                    | output (collector) |  |  |
| 3                                    | GND (emitter)      |  |  |
| <b>SOT23; SOT323; SOT346; SOT416</b> |                    |  |   |
| 1                                    | input (base)       |  |  |
| 2                                    | GND (emitter)      |  |  |
| 3                                    | output (collector) |  |  |
| <b>SOT883</b>                        |                    |  |   |
| 1                                    | input (base)       |  |  |
| 2                                    | GND (emitter)      |  |  |
| 3                                    | output (collector) |  |  |

### 3. Ordering information

Table 4. Ordering information

| Type number              | Package |   |         |
|--------------------------|---------|---|---------|
|                          | Name    | Description   | Version |
| PDTA123TE                | SC-75   | plastic surface mounted package; 3 leads                                      | SOT416  |
| PDTA123TK                | SC-59A  | plastic surface mounted package; 3 leads                                      | SOT346  |
| PDTA123TM                | SC-101  | leadless ultra small plastic package; 3 solder lands; body 1.0 × 0.6 × 0.5 mm | SOT883  |
| PDTA123TS <sup>[1]</sup> | SC-43A  | plastic single-ended leaded (through hole) package; 3 leads                   | SOT54   |
| PDTA123TT                | -       | plastic surface mounted package; 3 leads                                      | SOT23   |
| PDTA123TU                | SC-70   | plastic surface mounted package; 3 leads                                      | SOT323  |

[1] Also available in SOT54A and SOT54 variant packages (see [Section 2](#) and [Section 9](#))

### 4. Marking

Table 5. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PDTA123TE   | 2A                          |
| PDTA123TK   | GA                          |
| PDTA123TM   | FA                          |
| PDTA123TS   | TA123T                      |
| PDTA123TT   | ZL*                         |
| PDTA123TU   | *1S                         |

[1] \* = -: made in Hong Kong

\* = p: made in Hong Kong

\* = t: made in Malaysia

\* = W: made in China

## 5. Limiting values

**Table 6. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions  | Min    | Max  | Unit   |
|------------------|---------------------------|---|--------|------|--------|
| V <sub>CBO</sub> | collector-base voltage    | open emitter                                      | -      | -50  | V      |
| V <sub>CEO</sub> | collector-emitter voltage | open base   | -      | -50  | V      |
| V <sub>EBO</sub> | emitter-base voltage      | open collector                                    | -      | -5   | V      |
| I <sub>O</sub>   | output current            |   | -      | -100 | mA     |
| I <sub>CM</sub>  | peak collector current    | single pulse;<br>$t_p \leq 1 \text{ ms}$          | -      | -100 | mA     |
| P <sub>tot</sub> | total power dissipation   | $T_{\text{amb}} \leq 25 \text{ }^{\circ}\text{C}$ |        |      |        |
|                  | SOT416                    |   | [1]    | -    | 150 mW |
|                  | SOT346                    |   | [1]    | -    | 250 mW |
|                  | SOT883                    |   | [2][3] | -    | 250 mW |
|                  | SOT54                     |   | [1]    | -    | 500 mW |
|                  | SOT23                     |   | [1]    | -    | 250 mW |
|                  | SOT323                    |   | [1]    | -    | 200 mW |
| T <sub>stg</sub> | storage temperature       |   | -65    | +150 | °C     |
| T <sub>j</sub>   | junction temperature      |   | -      | 150  | °C     |
| T <sub>amb</sub> | ambient temperature       |   | -65    | +150 | °C     |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

## 6. Thermal characteristics

**Table 7. Thermal characteristics**

| Symbol               | Parameter                                   | Conditions  | Min    | Typ | Max | Unit    |
|----------------------|---|-------------|--------|-----|-----|---------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air |        |     |     |         |
|                      | SOT416                                      |             | [1]    | -   | -   | 833 K/W |
|                      | SOT346                                      |             | [1]    | -   | -   | 500 K/W |
|                      | SOT883                                      |             | [2][3] | -   | -   | 500 K/W |
|                      | SOT54                                       |             | [1]    | -   | -   | 250 K/W |
|                      | SOT23                                       |             | [1]    | -   | -   | 500 K/W |
|                      | SOT323                                      |             | [1]    | -   | -   | 625 K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

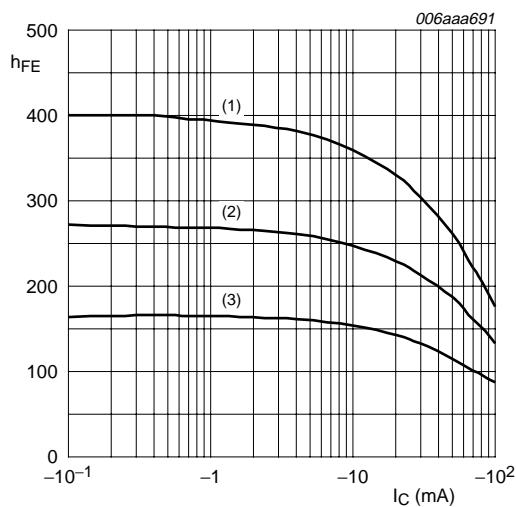
[3] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

## 7. Characteristics

**Table 8. Characteristics**

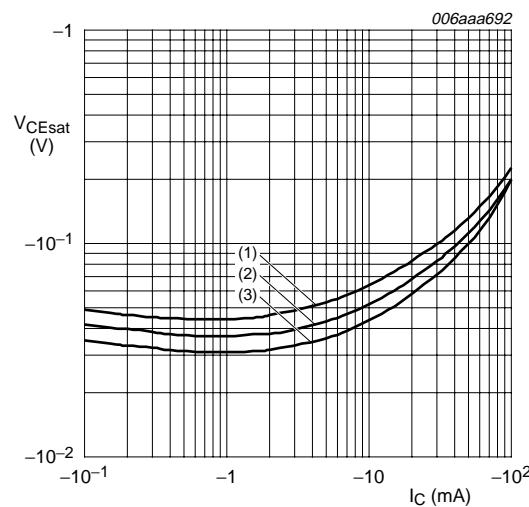
$T_{amb} = 25^\circ\text{C}$  unless otherwise specified

| Symbol      | Parameter                            | Conditions   | Min | Typ  | Max  | Unit |    |
|-------------|--------------------------------------|--|-----|------|------|------|----|
| $I_{CBO}$   | collector-base cut-off current       | $V_{CB} = -50\text{ V}$ ; $I_E = 0\text{ A}$                             | -   | -    | -100 | nA   |    |
| $I_{CEO}$   | collector-emitter cut-off current    | $V_{CE} = -30\text{ V}$ ; $I_B = 0\text{ A}$                             | -   | -    | -1   | μA   |    |
|             |                                      | $V_{CE} = -30\text{ V}$ ; $I_B = 0\text{ A}$ ; $T_j = 150^\circ\text{C}$ | -   | -    | -50  | μA   |    |
| $I_{EBO}$   | emitter-base cut-off current         | $V_{EB} = -5\text{ V}$ ; $I_C = 0\text{ A}$                              | -   | -    | -100 | nA   |    |
| $h_{FE}$    | DC current gain                      | $V_{CE} = -5\text{ V}$ ; $I_C = -20\text{ mA}$                           | 30  | -    | -    | -    |    |
| $V_{CEsat}$ | collector-emitter saturation voltage | $I_C = -10\text{ mA}$ ; $I_B = -0.5\text{ mA}$                           | -   | -    | -150 | mV   |    |
| $R_1$       | bias resistor 1 (input)              |  |     | 1.54 | 2.2  | 2.86 | kΩ |
| $C_c$       | collector capacitance                | $V_{CB} = -10\text{ V}$ ; $I_E = i_e = 0\text{ A}$ ; $f = 1\text{ MHz}$  | -   | -    | 3    | pF   |    |



$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = 100^\circ\text{C}$   
 (2)  $T_{amb} = 25^\circ\text{C}$   
 (3)  $T_{amb} = -40^\circ\text{C}$

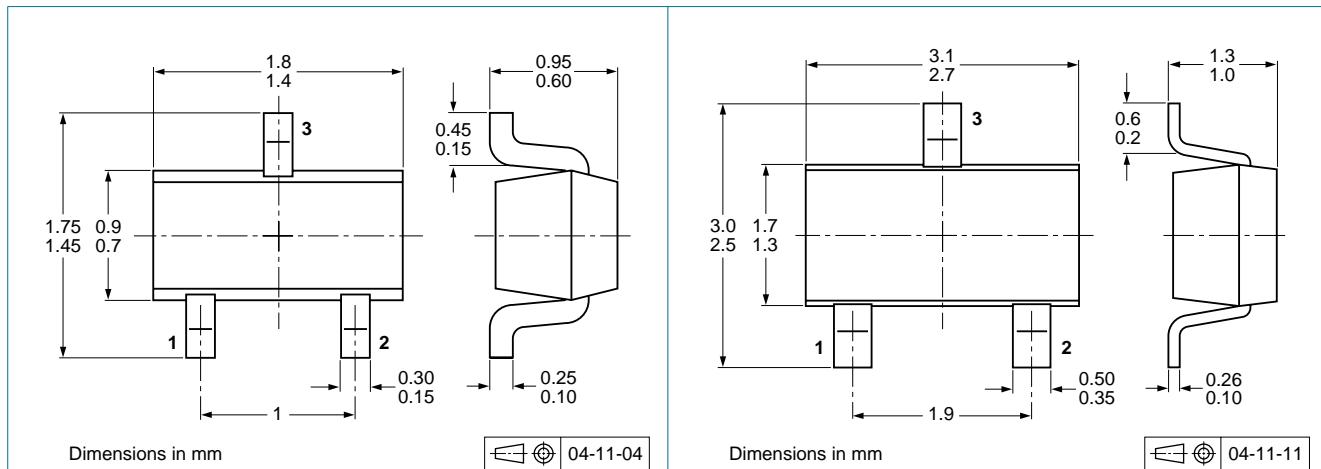
**Fig 1. DC current gain as a function of collector current; typical values**



$I_C/I_B = 20$   
 (1)  $T_{amb} = 100^\circ\text{C}$   
 (2)  $T_{amb} = 25^\circ\text{C}$   
 (3)  $T_{amb} = -40^\circ\text{C}$

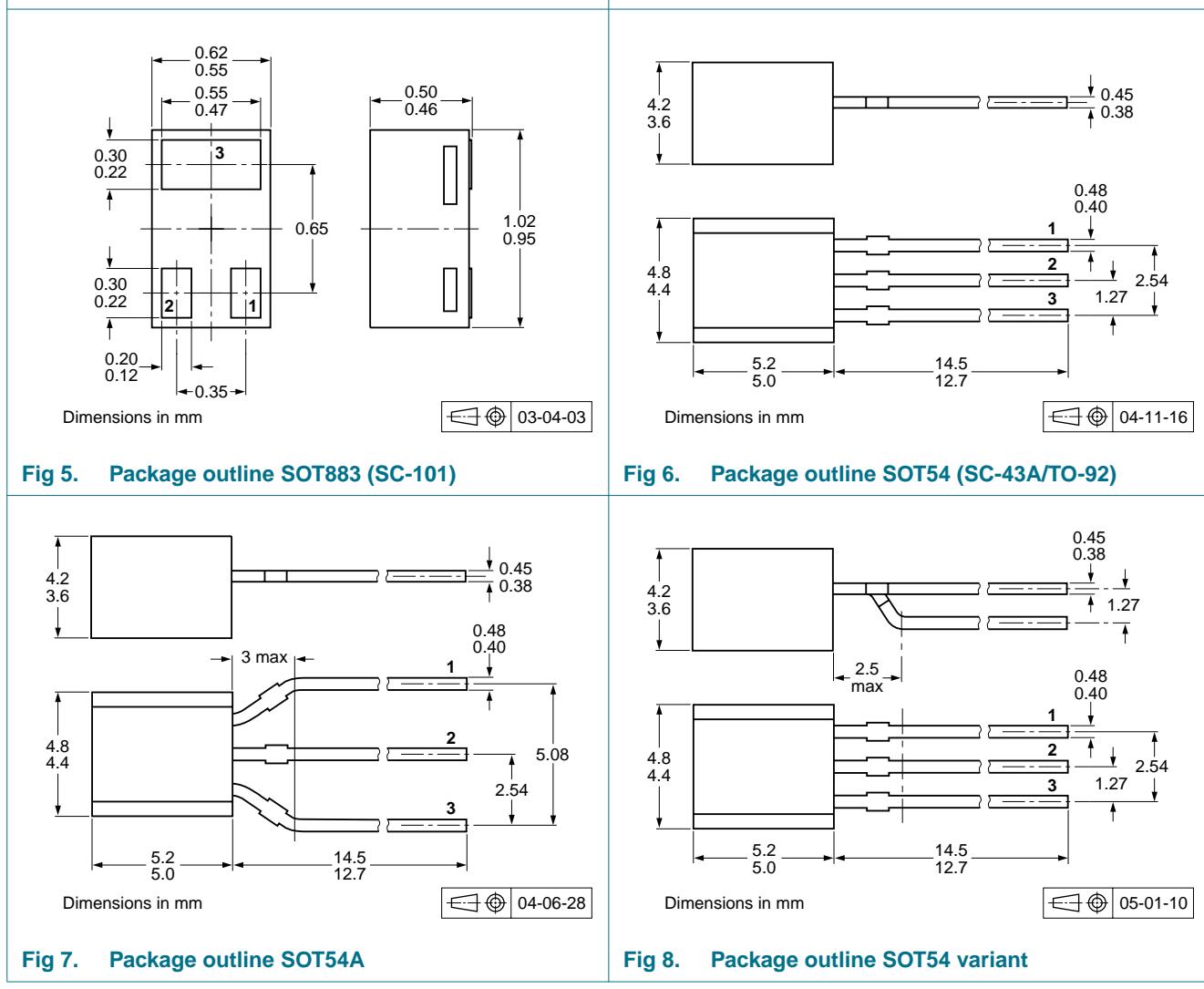
**Fig 2. Collector-emitter saturation voltage as a function of collector current; typical values**

## 8. Package outline



**Fig 3. Package outline SOT416 (SC-75)**

**Fig 4. Package outline SOT346 (SC-59A/TO-236)**



**Fig 7. Package outline SOT54A**

**Fig 8. Package outline SOT54 variant**

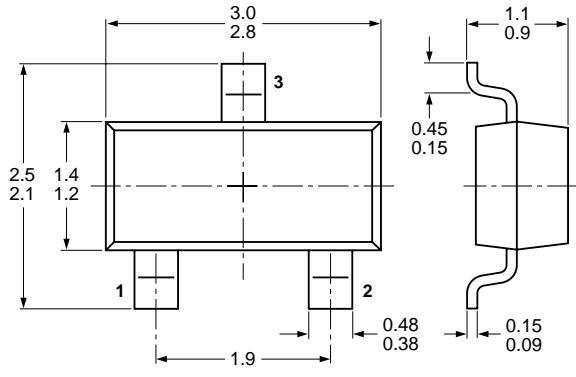


Fig 9. Package outline SOT23 (TO-236AB)

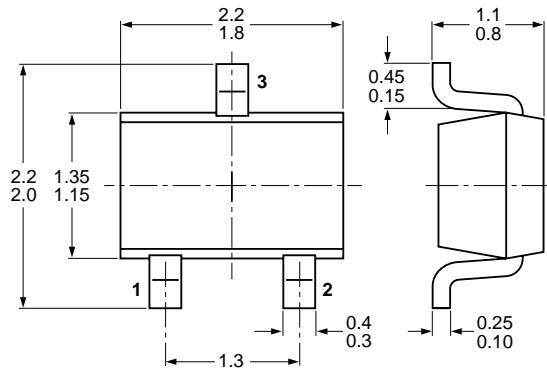


Fig 10. Package outline SOT323 (SC-70)

## 9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

| Type number | Package       | Description                    | Packing quantity |      |       |
|-------------|---------------|--------------------------------|------------------|------|-------|
|             |               |                                | 3000             | 5000 | 10000 |
| PDTA123TE   | SOT416        | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |
| PDTA123TK   | SOT346        | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |
| PDTA123TM   | SOT883        | 2 mm pitch, 8 mm tape and reel | -                | -    | -315  |
| PDTA123TS   | SOT54         | bulk, straight leads           | -                | -412 | -     |
|             | SOT54A        | tape and reel, wide pitch      | -                | -    | -116  |
|             |               | tape ammopack, wide pitch      | -                | -    | -126  |
|             | SOT54 variant | bulk, delta pinning            | -                | -112 | -     |
| PDTA123TT   | SOT23         | 4 mm pitch, 8 mm tape and reel | -215             | -    | -235  |
| PDTA123TU   | SOT323        | 4 mm pitch, 8 mm tape and reel | -115             | -    | -135  |

[1] For further information and the availability of packing methods, see [Section 12](#).

## 10. Revision history

**Table 10. Revision history**

| Document ID    | Release date  | Data sheet status  | Change notice | Supersedes     |
|----------------|---|--------------------|---------------|----------------|
| PDTA123T_SER_2 | 20090903  | Product data sheet | -             | PDTA123T_SER_1 |
| Modifications: | <ul style="list-style-type: none"><li>• This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content.</li></ul> |                    |               |                |
| PDTA123T_SER_1 | 20060307  | Product data sheet | -             | -              |

## 11. Legal information

### 11.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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## 13. Contents

|           |                                |           |
|-----------|--------------------------------|-----------|
| <b>1</b>  | <b>Product profile</b>         | <b>1</b>  |
| 1.1       | General description            | 1         |
| 1.2       | Features                       | 1         |
| 1.3       | Applications                   | 1         |
| 1.4       | Quick reference data           | 1         |
| <b>2</b>  | <b>Pinning information</b>     | <b>2</b>  |
| <b>3</b>  | <b>Ordering information</b>    | <b>3</b>  |
| <b>4</b>  | <b>Marking</b>                 | <b>3</b>  |
| <b>5</b>  | <b>Limiting values</b>         | <b>4</b>  |
| <b>6</b>  | <b>Thermal characteristics</b> | <b>4</b>  |
| <b>7</b>  | <b>Characteristics</b>         | <b>5</b>  |
| <b>8</b>  | <b>Package outline</b>         | <b>6</b>  |
| <b>9</b>  | <b>Packing information</b>     | <b>7</b>  |
| <b>10</b> | <b>Revision history</b>        | <b>8</b>  |
| <b>11</b> | <b>Legal information</b>       | <b>9</b>  |
| 11.1      | Data sheet status              | 9         |
| 11.2      | Definitions                    | 9         |
| 11.3      | Disclaimers                    | 9         |
| 11.4      | Trademarks                     | 9         |
| <b>12</b> | <b>Contact information</b>     | <b>9</b>  |
| <b>13</b> | <b>Contents</b>                | <b>10</b> |

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